

WHAT IS CLAIMED IS:

1       1. A semiconductor laser, comprising;  
2              a semiconductor substrate;  
3                  a laser layer on said semiconductor substrate;  
4              at least two waveguide ridges located at a distance from  
5              said laser layer, and  
6                  a first strip-shaped lattice structure comprising  
7              alternating portions of conducting and non-conducting or  
8              less conducting material, wherein said lattice structure is  
9              located on the flat portions of the surface between said  
10             ridges and at a distance from said laser layer above said  
11             laser layer.

1       2. A semiconductor laser according to claim 1, further  
2              comprising a second strip-shaped lattice structure located  
3              lateral to the two outermost of said waveguide ridges,  
4              wherein said lattice structure is located on the flat  
5              portions of the surfaces lateral to said outermost ridges  
6              and at a distance from said laser layer above said laser  
7              layer.

1       3. The semiconductor laser according to claim 1, wherein  
2              said lattice structure is located on a barrier or  
3              insulating layer wherein said barrier defines the position  
4              of said lattice structure relative to said laser layer.

1       4. The semiconductor laser according to claim 1, wherein  
2              said lattice structure comprises a metal.

1       5. The semiconductor laser according to claim 4, wherein  
2       said metal is chromium or a chromium alloy.

1       6. The semiconductor laser according to claim 1, wherein  
2       said first strip-shaped lattice structure is located  
3       adjacent to sides of said waveguide ridges, and wherein the  
4       width and spacing of said waveguide ridges are selected  
5       such that base points of the sides of said waveguide ridges  
6       are located in a peripheral region of radiation from an  
7       active zone of said laser layer.

1       7. A process for the production of a semiconductor laser  
2       based on a semiconductor substrate with a laser layer  
3       arranged on said semiconductor substrate and a strip-shaped  
4       lattice structure, the process comprising the steps of:

5           a) producing a complete semiconductor laser structure  
6       in an epitaxial process;

7           b) forming at least two waveguide ridges by removing  
8       material from said semiconductor;

9           c) laser structure so as to form carrier surfaces  
10      between said waveguide ridges and lateral to the outer of  
11      said waveguide ridges; and

12          d) applying a lattice structure to said carrier  
13      surfaces.

1       8. The process according to claim 7, wherein, preceding  
2       step (d), the step of forming an insulating layer on said  
3       carrier surfaces.

1       9. The process according to claim 8, wherein said lattice  
2       structure comprises alternating portions of a conductive  
3       and non-conductive or less conductive material.

1       10. The process according to claim 9, wherein said step of  
2       applying a lattice structure includes applying a metallic  
3       lattice structure with a lithographic process, comprising  
4       the steps of performing a lithographic process to create a  
5       lithographic structure and metallization of said  
6       lithographic structure.